Silicon P-Channel MOS FET

HITACHI

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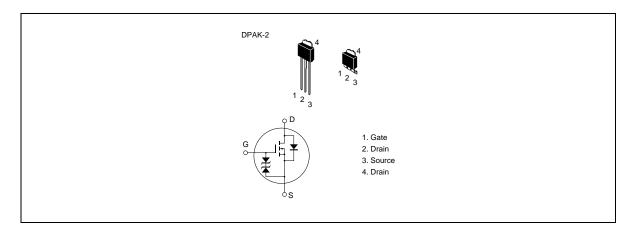
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 2.5 V Gate drive device can be driven from 3 V Source
- Suitable for Switching regulator, DC DC converter

Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	-30	V
Gate to source voltage	V _{gss}	±20	V
Drain current	I _D	-10	А
Drain peak current	↓ D(pulse)	-40	А
Body to drain diode reverse drain current	I _{DR}	-10	А
Channel dissipation	Pch* ²	20	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

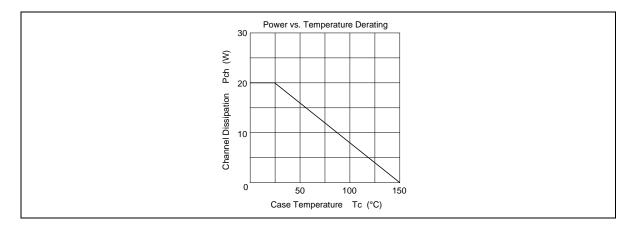
Notes 1. $PW \le 10 \ \mu s$, duty cycle $\le 1\%$

2. Value at Tc = 25°C

Electrical Characteristics (Ta = 25°C)

V	$I_{p} = -10 \text{ mA}, V_{gs} = 0$
	D 2011, GS 0
V	$I_{_{\rm G}} = \pm 100 \ \mu \text{A}, \ V_{_{\rm DS}} = 0$
μA	$V_{_{\rm GS}} = \pm 16 \text{ V}, \text{ V}_{_{\rm DS}} = 0$
μA	$V_{_{DS}} = -25 \text{ V}, \text{ V}_{_{GS}} = 0$
V	$I_{_{D}} = -1 \text{ mA}, V_{_{DS}} = -10 \text{ V}$
Ω	$I_{_{D}} = -5 \text{ A}$ $V_{_{GS}} = -10 \text{ V}^{*1}$
Ω	$I_{_{D}} = -5 \text{ A}$ $V_{_{GS}} = -2.5 \text{ V}^{*1}$
S	$I_{_{D}} = -5 \text{ A}$ $V_{_{DS}} = -10 \text{ V}^{*1}$
pF	V _{DS} = -10 V
pF	$V_{\rm GS} = 0$
pF	f = 1 MHz
ns	$I_{D} = -5 \text{ A}$
ns	$V_{gs} = -10 V$
ns	$R_{L} = 6 \Omega$
ns	-
V	$I_{_{\rm F}} = -10$ A, $V_{_{\rm GS}} = 0$
μs	$I_{_F} = -10 \text{ A}, V_{_{GS}} = 0,$ diF/dt = 20 A/µs
	pF ns ns ns ns V

Note 1. Pulse Test



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